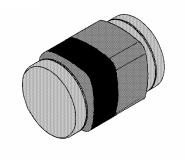
### SILICON EPITAXIAL PLANAR DIODE

#### **Features**

- Fast switching diode
- Fits onto SOD 323 / SOT 23 footprints
- Micro Melf package

LS-31



## Absolute Maximum Ratings (T<sub>a</sub> = 25°C)

	Symbol	Value	Unit
Reverse Voltage	$V_R$	220	V
Peak Reverse Voltage	$V_{RM}$	250	V
Mean Rectified Current	Io	200	mA
Half Wave Rectification with Resistance			
load at $T_{amb} = 25^{\circ}C$ and f/50 $H_Z$			
Maximum Forward Current	I <sub>FM</sub>	625	mA
Surge Forward Current at t<1s and T <sub>j</sub> = 25°C	I <sub>FSM</sub>	1000	mA
Junction Temperature	T <sub>j</sub>	175	оС
Storage Temperature Range	Ts	-65 to +175	оС
1) Valid provided that electrodes are kept at ambient t	omporatura		•

<sup>1)</sup> Valid provided that electrodes are kept at ambient temperature









# Characteristics at $T_j = 25^{\circ}C$

	Symbol	Min.	Тур.	Max.	Unit
Forward Voltage					
at I <sub>F</sub> = 200mA	$V_{F}$	-	-	1.5	V
Leakage Current					
at V <sub>R</sub> = 220V	$I_R$	-	-	10	μΑ
Reverse Breakdown Voltage					
tested with 100uA Pulses	$V_{BR}$	250	-	-	V
Capacitance					
at $V_F = V_R = 0$ , $f = 1MHz$	$C_{tot}$	-	-	3	pF
Reverse Recovery Time					
From $I_F = I_R = 20mA$	t <sub>rr</sub>	-	-	75	ns

# **Dimensions in mm** Cathode indification 1.35 max. Glass Ø1.25 -0.05 R≥2.5 Glass 0.21+0.05 2.0+/-0.1Glass case technical drawings Micro MELF according to DIN specifications











